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AMINED BY:		FILE NO . CAS-0006581
Yung Chang Hu	EMERGING DISPLAY	ISSUE : JAN.28, 2008
PROVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 29
David Chang		VERSION: 1
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
CUSTOMER'S APPROV	DEL NO.: ET057009DHU (RoHS) MESSRS:	
DATE:		
BY:		

EMERGING DISPLAY MODEL NO. VERSIO	ON PAGE
TECHNOLOGIES CORPORATION ET057009DHU 1	0-1
DOC . FIRST ISSUE	
RECORDS OF REVISION	JAN.28, 2008
DATE PAGE SUMMARY	
NO.	

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1. GENERAL	SPECIFICATIONS			

1.1 APPLICATION NOTES FOR CONTROLLER/DRIVER PLEASE REFER TO:

HIMAX HX8250 HIMAX HX8678

1.2 MATERIAL SAFETY DESCRIPTION
ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS,
INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD,
MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED
BIPHENYLS (PBB) AND POLYBROMINATED
DIPHENYL ETHERS (PBDE)

2.	MECHANICAL SPECIFICATIONS (1) DIAGONALS	5.7 inch
	(2) NUMBER OF DOTS	640W * (RGB) * 480H DOTS
	(3) MODULE SIZE	124.7W * 100.0H *12.5D (MAX) mm
		(WITHOUT FPC)
	(4) EFFECTIVE AREA	117.2W * 88.4H mm (T/P)
	(5) ACTIVE AREA	115.2W * 86.4H mm (LCD)
		116.2W * 87.4H mm (T/P)
	(6) DOT SIZE	0.06W * 0.18H mm
	(7) PIXEL SIZE	0.18W * 0.18H mm
	(8) LCD TYPE	TFT , TRANSMISSIVE
	(9) COLOR	16.7M
	(10) VIEWING DIRECTION	12 O'CLOCK
	(11) BACK LIGHT	LED , COLOR : WHITE
	(12) INTERFACE MODE	RGB 24BIT PARALLEL (DE/SYNC MODE)

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3. ABSOLUTE MAXIMUM RATINGS

3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

VSS = 0V

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY	VCC	-0.3	7.0	V	
VOLTAGE	VDD	-0.3	7.0	V	
INPUT SIGNAL VOLTAGE	Vi	- 0.3	VCC+0.3	V	
LED BACKLIGHT	PD		1.28	W	
DISSIPATION	10		1.20	VV	
LED BACKLIGHT	IF		0.06	Α	
CURRENT			0.00	71	
LED BACKLIGHT	VR		45	V	
REVERSE VOLTAGE	V IX		73	•	

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

ITEM	OPERATING		STORAGE		REMARK	
I I E IVI	MIN.	MAX. MIN.		MAX.	KEMAKK	
AMBIENT TEMPERATURE	-10°C	60°C	-20°C	70°C	NOTE(1),(2)	
HUMIDITY	NOTI	E(3)	NOTE(3)		WITHOUT CONDENSATION	
VIBRATION		2.45 m/s ² (0.25 G)	_	11.76 m/s ² (1.2 G)	10~55Hz X,Y,Z,EACH 2HRS	
SHOCK	_	29.4 m/s ² (3 G)		490 m/s ² (50 G)	6 m SECONDS XYZ DIRECTIONS 3 TIME EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACCEPTABLE			

NOTE (1): Ta AT -20°C: 48HR MAX.

70°C:168HR MAX.

NOTE (2): BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT TEMPERATURE

THIS PHENOMENON IS REVERSIBLE.

NOTE (3) : $Ta \le 60$ °C: 90%RH MAX (96HRS MAX).

 $\mbox{Ta} > 60\mbox{°C}: \mbox{ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY}$

OF 90%RH AT 60°C(96HRS MAX).

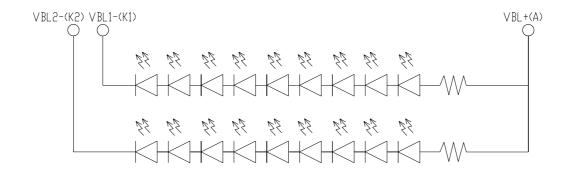
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4. ELECTRICAL CHARACTERISTICS

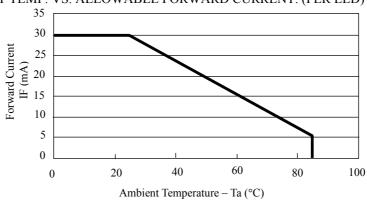
 $Ta = 25 \, ^{\circ}C$

							1a – 23 C
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY	VDD		3	3.3	3.6	V	
VOLTAGE FOR VCOM	V DD		3	3.3	3.0	V	
POWER SUPPLY	VCC		3	3.3	3.6	V	
VOLTAGE FOR LCD	VCC		3	3.3	3.0	•	
POWER SUPPLY	IDD	VDD=3.3V		510	600	mA	
CURRENT FOR VOCM	IDD	LED B/L=ON		310	000	ША	
POWER SUPPLY	ICC	VCC = 3.3V		8	12	mA	
CURRENT FOR LCD	icc	VCC - 3.3 V		o	12	ША	
LOW LEVEL INPUT	VIL		0		0.3*VCC	V	
VOLTAGE	VIL —	U		0.5 VCC	v		
HIGH LEVEL INPUT	VIH		0.7*VCC		VCC	V	
VOLTAGE	V 111		0.7 VCC		VCC	,	
OUTPUT LOW VOLTAGE	VOL	$IOL = 400 \mu A$	0	—	0.2*VCC	V	
OUTPUT HIGH VOLTAGE	VOH	$IOH = -400 \mu A$	0.8*VCC		VCC	V	
FRAME FREQUENCY	fFRAME	_	50	60	72	Hz	
LED BACKLIGHT	V	I =40m A	28	30	32	V	NOTE (1)
FORWARD VOLTAGE	V_{F}	$I_F=40mA$	28	30	32	v	NOTE (1)
LED LIFE TIME	_		30000	40000		hr	

NOTE (1): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



NOTE (2): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT. (PER LED)

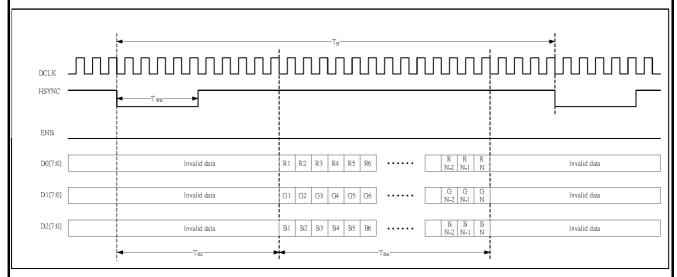


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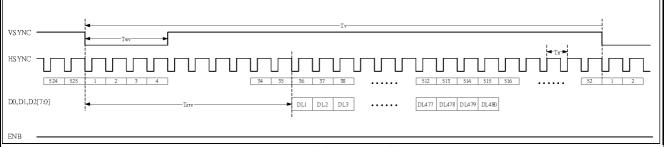
5. TIMING CHART

5.1 DIGITAL PARALLEL RGB INTERFACE (SYNC MODE)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQUENCY	F_{CPH}	22.66	25.175	27.69	MHz
DCLK PERIOD	T_{CPH}	36.11	39.7	44.13	ns
DCLK PULSE DUTY	T_{CWH}	40	50	60	%
HSYNC PERIOD	T_{H}	750	800	850	T_{CPH}
HSYNC PULSE WIDTH	$T_{ m WH}$	5	30	_	T_{CPH}
HSYNC FIRST HORIZONTAL DATA TIME	T_{HS}	112	144	175	T_{CPH}
HORIZONTAL ACTIVE DATA AREA	T_{HA}	_	640	_	T_{CPH}
VSYNC PULSE WIDTH	T_{WV}	1	3	5	T_{H}
FIRST LINE DATA INPUT TIME	T_{STV}	_	35	_	T_{H}
VSYNC PERIOD	$T_{\mathbf{V}}$	515	525	535	T_{H}



HORIZONTAL TIMING

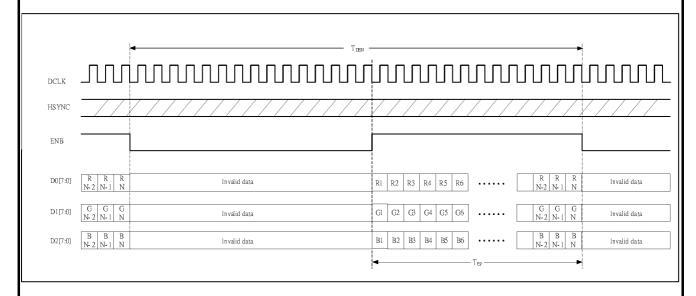


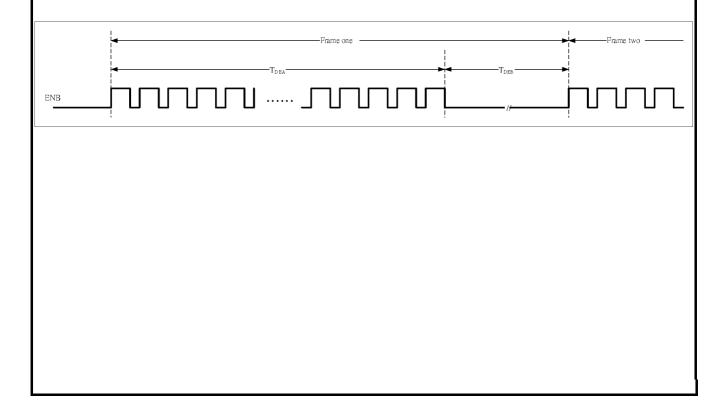
VERTICAL TIMING

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5.2 DIGITAL PARALLEL RGB INTERFACE (DE MODE)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQUENCY	F_{CPH}	22.66	25.175	27.69	MHz
DCLK PERIOD	T_{CPH}	36.11	39.7	44.13	ns
DCLK PULSE DUTY	T_{CWH}	40	50	60	%
ENB PERIOD	T_{DEN}	750	800	850	T_{CPH}
ENB PULSE WIDTH	T_{EP}	_	640	_	T_{CPH}
ENB FRAME ACTIVE TIME	T_{DEA}	_	480	_	T_{H}
ENB FRAME BLANKING TIME	T_{DEB}	10	45	110	T_{H}





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6. OPTICAL CHARACTERISTICS (NOTE1)

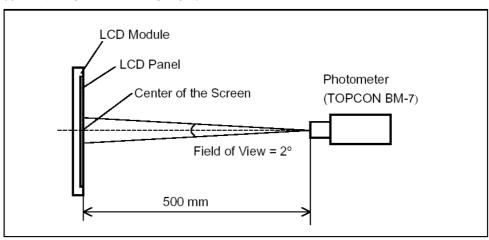
6.1 OPTICAL CHARACTERISTICS

 $Ta = 25 \pm 2 \, ^{\circ}C$

I T E	M	SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK	
					θ _x =0°	50	55			
VIEWING ANGL	E	$\theta_{ ext{y-}}$	CR ≥ 10		47	52		daa	(2)	
VIEWING ANGL	L	θ_{x^+}	CK ≥ 10	θ _v =0°	60	65		deg.	(3)	
		θ_{x}		0 _y -0	60	65				
CONTRAST RAT	ΊΟ	CR	θx=0°,	θy=0°	300	350			(3)	
RESPONSE TIME	3	T _R (rise)	0v-0°	Δx/=0°		15	30	msec	(4)	
RESI ONSE TIVII	<u> </u>	T_F (fall)	$\theta x=0^{\circ}$, $\theta y=0^{\circ}$		—	35	50	msec	(4)	
THE BRIGHTNESS OF MODULE		В		θy=0° 40mA	350	400	_	cd/m ₂	(5)	
	WHITE	Wx			0.26	0.31	0.36			
	WHITE	Wy			0.30	0.35	0.40			
COLOR OF	RED	Rx			0.56	0.61	0.66			
COLOR OF CIE	KED	Ry		θy=0° 40mA	0.31	0.36	0.41		(6)	
COORDINATE	GREEN	Gx		: 50 %	0.28	0.33	0.38		(0)	
COORDINATE	INTE ORDER	Gy			0.51	0.56	0.61			
	DITIE	Bx			0.09	0.14	0.19			
	BLUE	BLUE	Ву			0.07	0.12	0.17		
THE UNIFORMIT	ГҮ ОБ	_	IF = 4	40mA	75	80		%	_	

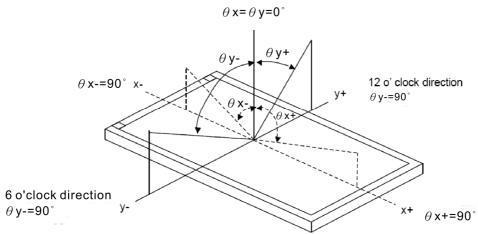
NOTE (1): TEST EQUIPMENT SETUP:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 2° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



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NOTE (2): DEFINITION OF VIEWING ANGLE:

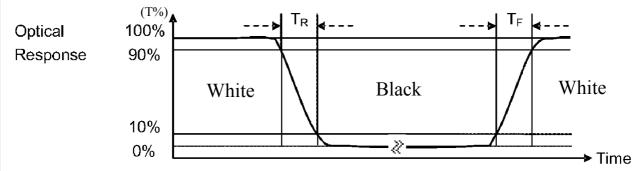


Normal

NOTE (3): DEFINITION OF CONTRAST RATIO:

 $CONTRASTRATIO(CR) = \frac{BRIGHTNESS\ MEASURED\ WHEN\ LCD\ IS\ AT\ "WHITE\ STATE"}{BRIGHTNESS\ MEASURED\ WHEN\ LCD\ IS\ AT\ "BLACK\ STATE"}$

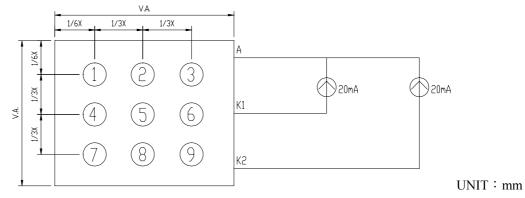
NOTE (4): DEFINITION OF RESPONSE TIME: TR AND TF
THE FIGURE BVELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



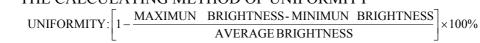
NOTE (5): BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"

NOTE (6): THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.

6.2 THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY

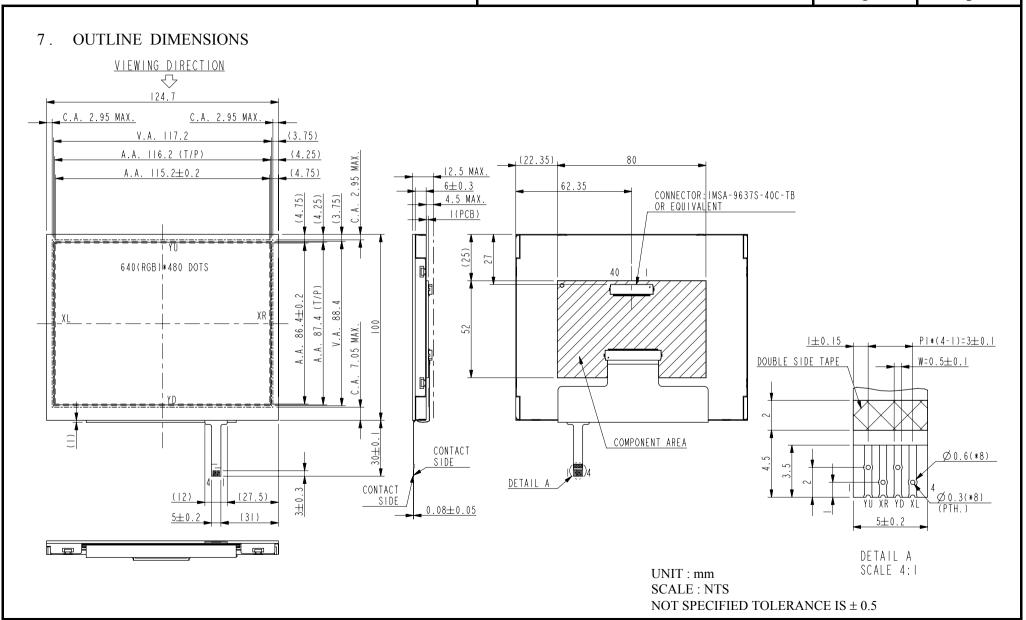


6.3 THE CALCULATING METHOD OF UNIFORMITY



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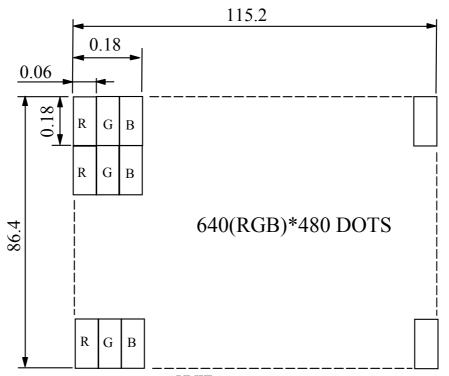
MODEL NO. VERSION PAGE EMERGING DISPLAY TECHNOLOGIES CORPORATION ET057009DHU 9 1 8. BLOCK DIAGRAM TFT LCD PANEL GATE DRIVER SOURCE DRIVER T-C \square N PCB VBL+ LED TOUCH VGL,VGH VBL1-BACKLIGHT PANEL VCOM, VCC, VDD, VDDA VBL2-V1,V2,V3,V4

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9. DETAIL DRAWING OF DOT MATRIX



UNIT : mm SCALE : NTS

NOT SPECIFIED TOLERANCE IS \pm 0.1 DOTS MATRIX TOLERANCE IS \pm 0.01

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10. INTERFACE SIGNALS

PIN NO	SYMBOL	I/O		FUNCTION				
1	LR	I	LR=H : STH→S	LR=H : $STH \rightarrow S01 \rightarrow \rightarrow S0960 \rightarrow STHO$				
1	LK	1	$LR=L: STH \rightarrow S960 \rightarrow \rightarrow S01 \rightarrow STHO$					
				UP/DOWN SCAN SETTING				
2	UD	I	· ·	UD=H, REVERSE SCAN				
2 1	MCC	D	UD=L, NORMA	L SCAN				
3,4	VSS	Р	GROUND CLIPPI	V FOR VOON PRIVER OF	CUIT			
5	VDD	P		Y FOR VCOM DRIVER CIR				
6	VDD	P	POWER SUPPL	Y FOR VCOM DRIVER CIR	CUIT			
				PWCTRL	REMARK			
7	PWCTRL	I	LOGIC LEVEL	Н	POWER ON			
			H = 3.3V $L=0V$	L	SHUTDOWN			
8	LEDCTRL	I	BRIGHTNESS	CONTROL FOR LED B/L				
9	ENB	I	DATA ENABLE	EINPUT				
10	VSYNC	I	VERTICAL SY	NC INPUT				
11	HSYNC	I	HORIZONTAL	SYNC INPUT				
12	DCLK	I	DOT DATA CO	LOCK				
13	VSS	P	GROUND					
14	R0	I	RED DATA BIT	RED DATA BIT 0				
15	R1	I	RED DATA BIT 1					
16	R2	I	RED DATA BIT 2					
17	R3	I	RED DATA BIT 3					
18	R4	I	RED DATA BIT	RED DATA BIT 4				
19	R5	I	RED DATA BIT 5					
20	R6	I	RED DATA BIT	6				
21	R7	I	RED DATA BIT	7				
22	G0	I	GREEN DATA	BIT 0				
23	G1	I	GREEN DATA	BIT 1				
24	G2	I	GREEN DATA	BIT 2				
25	G3	I	GREEN DATA BIT 3					
26	G4	I	GREEN DATA BIT 4					
27	G5	I	GREEN DATA BIT 5					
28	G6	I	GREEN DATA	GREEN DATA BIT 6				
29	G7	I	GREEN DATA	GREEN DATA BIT 7				
30	В0	I	BLUE DATA BIT 0					
31	B1	I	BLUE DATA BIT 1					
	ı		L					

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PIN NO	SYMBOL	I/O	FUNCTION
32	B2	I	BLUE DATA BIT 2
33	В3	I	BLUE DATA BIT 3
34	B4	I	BLUE DATA BIT 4
35	В5	I	BLUE DATA BIT 5
36	В6	I	BLUE DATA BIT 6
37	В7	I	BLUE DATA BIT 7
38	/RESET	I	HARDWARE RESET
39	VSS	P	GROUND
40	VCC	P	POWER SUPPLY FOR DIGITAL CIRCUIT

T/P INTERFACE

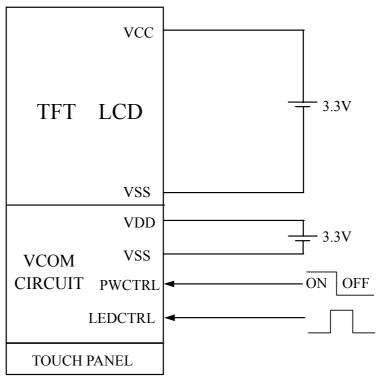
PIN NO	SYMBOL	FUNCTION
1	YU	TOP PANEL
2	XR	RIGHT PANEL
3	YD	BOTTOM PANEL
4	XL	LEFT PANEL

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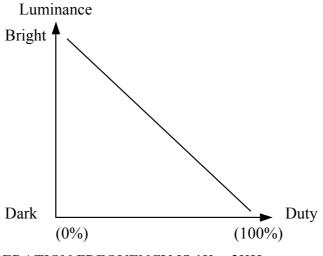
11. POWER SUPPLY

11.1 POWER SUPPLY FOR LCM

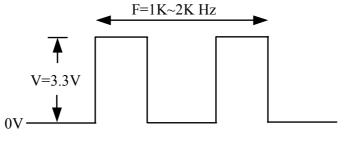


1 1 .2 THE BRIGHTNESS CONTROLLED BY PWM SIGNAL OF LEDCTRL

(1) IF THE DUTY IS BIGGER, THE BRIGHTNESS WILL BE LOWER.



(2) SIGNAL OPERATION FREQUENCY IS 1K ~ 2KHz.



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12. TOUCH PANEL SPECIFICATION

12.1 ELECTRICAL CHARACTERISTICS

 $Ta = 25^{\circ}C$

ITEM	CONDITION	SPEC.	UNIT
LINEARITY	_	≤ 1.5	%
TRANSMISSION	ASTM D1003	80 OR MORE	%
ON LOAD	POLYACETAL PEN INPUT	15 ~ 80	gg
TERMINAL RESISTANCE	X AXIS	400 ~ 1000	Ω
TERMINAL RESISTANCE	Y AXIS	$200 \sim 700$	22
INSULATION RESISTANCE	DC25V	≥ 10	$M\Omega$
INPUT VOLTAGE	_	5	V

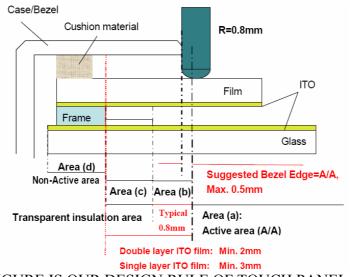
12.2 PRECAUTIONS IN USE OF TOUCH PANEL

12.2.1 PURPOSE:

IN ORDER TO PREVENT ACCIDENTAL USE AND PERFORMANCE DETERIORATION, PLEASE KEEP THE FOLLOWING PRECAUTIONS AND INHIBITED POINTS.

12.2.2 ITEM AND ILLUSTRATION:

(1) STRUCTURE, AREA DEFINITION
THE STRUCTURE AND THE PERFORMANCE GUARANTEED AREA OF THIS
TOUCH PANEL ARE DEFINED BELOW:



THE ABOVE FIGURE IS OUR DESIGN RULE OF TOUCH PANEL. IF IT CANNOT MEET YOUR REQUIREMENT, PLEASE CONTACT WITH OUR ENGINEERS FOR FURTHER DISCUSSION.

ABOVE FIGURE ILLUSTRATES THE RECOMMENDED BEZEL AND CUSHION DESIGN. IN ORDER TO PREVENT

UNUSUAL PERFORMANCE DEGRADATION AND MALFUNCTION OF A TOUCH PANEL, PLEASE CARRY OUT THE SET

CASE DESIGNING AND A TOUCH PANEL ASSEMBLING METHOD AFTER SURELY CONSIDERING THE DEFINITION OF EACH AREA ILLUSTRATED IN ABOVE FIGURE.

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AREA(a): ACTIVE AREA

THE ACTIVE AREA IS GUARANTEED THE POSITION DATA DETECTABLE PRECISION, OPERATION FORCE AND OTHER OPERATIONS. IT IS STRONGLY RECOMMENDED TO PLACE THE OPERATION BUTTON OR MENU KEYS WITHIN THE ACTIVE AREA. DUE TO STRUCTURE, THE ACTIVE AREA IS LESS DURABLE AT THE EDGE OR CLOSE TO THE EDGE.

AREA(b): OPERATION NON-GUARANTEED AREA

THIS AREA DOES NOT GUARANTEE A TOUCH PANEL OPERATION AND
ITS FUNCTION. WHEN THIS AREA IS PRESSED, TOUCH PANEL SHOWS
DEGRADATION OF ITS PERFORMANCE AND DURABILITY SUCH AS A PEN
SLIDING DURABILITY BECOMES ABOUT ONE-TENTH COMPARED WITH
THE ACTIVE AREA (AREA-(A) AS GUARANTEED AREA) AND ITS
OPERATION FORCE REQUIRES ABOUT DOUBLE. ABOUT 0.5 MM OUTSIDE
FROM A BOUNDARY OF THE ACTIVE AREA CORRESPONDS TO THIS AREA.

AREA(c): PRESSING PROHIBITION AREA

THE AREA WHICH FORBIDS PRESSING, BECAUSE AN EXCESSIVE LOAD IS
APPLIED TO A TRANSPARENT ELECTRODE (ITO) AND A SERIOUS DAMAGE
IS GIVEN TO A TOUCH PANEL FUNCTION BY PRESSING.

AREA(d): NON-ACTIVE AREA
THE AREA DOES NOT ACTIVATE EVEN IF PRESSED.

- (2) CAUTIONS FOR INSTALLING AND ASSEMBLING
 - (i) DO NOT GIVE EXCESSIVE STRAIN TO THE PRODUCT.

IT MAY CAUSE THE DAMAGE OF THE ITO FILM.

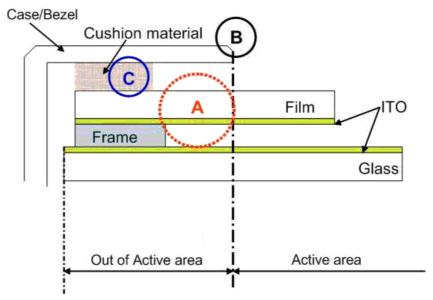
- (ii) FLEXIBLE PATTERN CABLE IS CONNECTED TO THE BODY BY THERMAL PRESSURE METHOD. SO, DO NOT APPLY EXCESSIVE FORCES TO THE FLEXIBLE PATTERN. DO NOT ADD AN EXCESSIVE FORCE TO A FPC(FLEX TAIL) THAT MAKES PEELING OFF OF THE FPC FROM THE PRODUCT. DO NOT FIX, ADHERE OR MOUNT ANY ADDITIONAL GOODS ON THE FPC SUCH AS ADDITIONAL FILM/PLATE ON THE FPC, BECAUSE SUCH ADDITIONAL GOODS WILL APPLY A STRESS AT THE FPC BONDING AREA. IT MAY AFFECT THE CONDUCTIVITY OF FPC WITH TOUCH PANEL.
- (iii) IN ORDER NOT TO APPLY LOAD ON THE DISPLAY, PROVIDE A CLEARANCE OF AT LEAST 0.3MM BETWEEN THE PRODUCT AND DISPLAY.
- (iv) WE RECOMMEND THE DESIGN OF A CASE OR BEZEL SHOULD COVERS THE BOUNDARY OF THE ACTIVE AREA INSIDE IN ORDER TO PREVENT AN OPERATION AT OUTSIDE OF THE ACTIVE AREA WHICH CAN NOT GUARANTEE THE FUNCTION OR DURABILITY (REFER TO ITEM 5.1.2. STRUCTURE, AREA DEFINITION).

 BEZEL'S EDGE PART MAY GUIDE THE PEN SLIDING ON THE SAME POSITION REPEATEDLY. IF THE BEZEL IS PLACED OUTSIDE OF THE ACTIVE AREA,

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(v) PRESSING INSIDE OF BOUNDARY OF THE FRAME(PART (A) AS SHOWN IN BELOW) MAY CAUSES FAULT OPERATION, SO PLEASE DESIGN TO AVOID PRESSING OF TOUCH PANEL AT PART (A) SUCH AS HAVING GASKET/CUSHION AT PART (C). PARTICULARLY THE AREA (B) SHALL BE FREE FROM BURR. THE GASKET/CUSHION MATERIAL AT THE PART (C) SHOULD NOT BE EXCEEDED TO INSIDE OF THE BOUNDARY OF THE FRAME.



- (vi) TO PREVENT GIVING DISTORTION TO THE FILM OF THE PRODUCT AND PEELING OFF OF THE FILM FROM THE PRODUCT, DO NOT FIX THE FILM AND A SET CASE OR A SHOCK ABSORBING MATERIAL ADHERED TO A SET CASE BY ADHESION.
- (vii) WIPE OFF THE STAIN ON THE PRODUCT BY USING SOFT CLOTH MOISTENED WITH ETHANOL. TAKE CARE NOT TO ALLOW ETHANOL TO SOAK INTO THE JOINT OF UPPER FILM AND BOTTOM GLASS. IT MAY OTHERWISE CAUSE PEELING OR DEFECTIVE OPERATION. DO NOT USE ANY ORGANIC SOLVENT OR DETERGENT OTHER THAN ETHANOL.
- (viii) THE CORNERS OF THE PRODUCT ARE NOT CHAMFERED AND ARE SHARP. WHEN POSITIONING AND FIXING THE PRODUCT ON THE CASE, PROVIDE A ROUND PART ON THE CORNER OF THE CASE SO AS NOT TO APPLY LOAD ON THE CORNER OF THE TRANSPARENT TOUCH PANEL.
 - (ix) DO NOT PRESS THE FILM OF THE PRODUCT WHEN THIS PRODUCT IS BUILT INTO A SET.
- (3) CAUTIONS FOR OPERATION
 - (i) OPERATE IT WITH A POLYACETAL PEN (TIP R0.8 OR OVER) OR A BELLY OF A FINGER WITHOUT APPLYING EXCESSIVE LOAD. NEVER USE ANY MECHANICAL PENCILS, BALL POINT PENS AND HARD FINGERTIPS WHOSE TIP IS HARD FOR INPUT, OTHERWISE MALFUNCTIONS MAY RESULT.

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- (ii) THE INPUT POSITION MAY BE FLUCTUATED A LITTLE THROUGH LONG-TIME USE. IT IS DESIRABLE TO PROVIDE A ZERO-ADJUSTMENT FUNCTION BY USING A CIRCUIT AND SOFTWARE.
- (iii) OPERATION AT THE OUT OF ACTIVE AREA IS OUT OF OUR GUARANTEE. IT CAUSES A SERIOUS DAMAGE OF A TRANSPARENT ELECTRODE. DO NOT OPERATE AT THE OUT OF ACTIVE AREA.
- (iv) IN CASE OF CLEANING THE PART OF THE CASE BOUNDARY OF ACCOMPLISHED SET, USE A SOFT CLOTH WITH A FINGER BERRY OR A COTTON BUD. DO NOT CLEAN WITH A THI NG OTHER THAN THE FINGER SUCH AS HARD OR SHARP EDGES LIKE A FINGER NAIL ETC. ON THE CLOTH, BECAUSE IT CAUSE TRANSPARENT CONDUCTIVE FILM CRACKS. PLEASE ADVISE THIS PROHIBITION TO YOUR LAST CUSTOMERS.

12.3 DURABILITY

12.3.1 STYLUS HITTING:

ONE MILLION TIMES OR OVER NO DAMAGE ON FILM SURFACE PEN: R8 mm SILICON RUBBER

LOAD: 250g

FREQUENCY: 240 times/min MEASUREMENT POSITION:

1 POINT OF TOUCH PANEL ACTIVE AREA

REPEATED: OVER 1,000,000 TIMES

12.3.2 PEN TOUCH SLIDING DURABILITY:

100,000 TIMES OR OVER

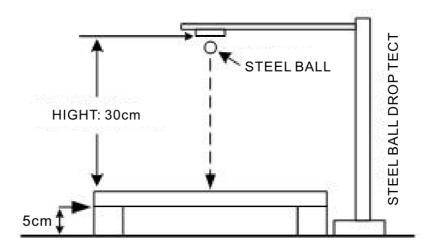
WRITING WITH R0.8mm PLASTIC STYLUS PEN; WRITING FORCE 150g IN ACTIVE AREA. SPEED IS 60mm/sec.

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12.4 STEEL BALL DROP TEST

BY USING F9mm STEEL BALL FROM THE HEIGHT OF 30cm AND FALLING ON TOUCH PANEL SURFACE, MUST PASS BELOW CONDITIONS:

APPEARANCE: THE APPEARANCE WITHOUT ANY CHANGE, INCLUDING THE PANEL BROKEN.



12.5 APPEARANCE INSPECTION

PURPOSE:

TO ESTABLISH APPEARANCE STANDARD AND MAINTAIN PRODUCT QUALITY \circ

SCOPE:

TOUCH PANEL VIEW AREA WITHIN TOUCH PANEL •

12.5.1 RULE:

INSPECTION CONDITION

- (A) ENVIRONMENTAL LUMINANCE: 500 LUX •
- (B) DISTANCE BETWEEN HUMAN EYES AND PANEL: 30 CM (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT) •
- (C) VISUAL ANGEL : $> 60^{\circ}$
- (D) LIGHT SOURCE: FLUORESCENT LIGHT SOURCE •

12.5.2 JUDGE CRITERION:

JUDGEMENT UNDER ABOVE MENTIONED CRITERION (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT),

TESTING GOODS DEFECT CAN BE VISIBLE WITHIN 10 SECONDS, WHICH WILL BE JUDGED AS MAJOR DEFECTS •

SAMPLING STANDARD:

THE SAMPLING STANDARD WILL BE CONFIRMED BY BOTH OF EDT AND CUSTOMER.

INSPECTION ITEMS		SEPC.	JUDGE CRITERION	OPERATION GUIDELINE
SCRATCH	$W \le 0.05$	mm & L≤10mm	ACCEPTABLE	REFL
SCRATCH	W > 0.051	mm or $L > 10$ mm	NOT ACCEPTABLE	BACK GROUND TESTING GOODS
LINEAR FOREIGN	$W \leq 0.03$	5mm & L ≤5mm	ACCEPTABLE	FLUORESCENT LIGHT SOURCE
OBJECT	W > 0.05	5mm or L >5mm	NOT ACCEPTABLE	300mm = €
	D:	≤ 0.25mm	ACCEPTABLE	60° ENVIRONMENTAL IUMINANCE 500Lux
GRANULAR FOREIGN OBJECT	0.25mm	n < D ≤0.30mm	MAX. 2 EA	REFL FLUORESCENT LIGHT SOURCE TESTING GOODS 300mm
OBJECT	D	>0.30mm	NOT ACCEPTABLE	ENVIRONMENTAL IUMINANCE 500Lux
PET BUBBLES	D	≤0.5mm	ACCEPTABLE	D
	D	>0.5mm	NOT ACCEPTABLE	D
CHIP ON GLASS	CORNER	$X \le 3$ mm $Y \le 3$ mm $Z < t$ $t = /t$ hickness	ACCEPTABLE	Chip of glass
	EDGE	$W \le 3mm \cdot Y \le 3mm \cdot Z < t$		X X X

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13. INSPECTION CRITERION

13.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) TO CUSTOMERS

13.2 INSPECTION CONDITIONS

13.2.1 (1)OBSERVATION DISTANCE: 35cm±5cm

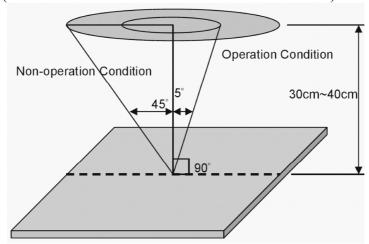
(2) VIEW ANGLE:

NON-OPERATION CONDITION: ±5°

(PERPENDICULAR TO LCD PANEL SURFACE)

OPERATION CONDITION: ±45°

(PERPENDICULAR TO LCD PANEL SURFACE)



13.2.2 ENVIRONMENT CONDITIONS:

AMBIEN	20°C~25°C	
AMBI	65±20%RH	
AMBIENT COSMETIC INSPECTION		MORE THAN 600Lux
ILLUMINATION FUNCTIONAL INSPECTION		300~500 Lux

13.2.3 INSPECTION LOT QUANTITY PER DELIVERY LOT FOR EACH MODEL

13.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY (a)APPLICABLE STANDARD:

MIL-STD-105E

NORMAL INSPECTION, SINGLE SAMPLING

Level II

(b)AQL : MAJOR DEFECT : AQL 0.65% MINOR DEFECT : AQL 1.0%

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13.3 INSPECTION STANDARDS

13.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
MAJOR DEFECT	1.DISPLAY ON	DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC	0.65
	2.BACKLIGHT	NO LIGHTFLICKERING AND OTHER ABNORMAL ILLUMINATION	0.65
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
	1.DISPLAY ZONE	 BLACK/WHITE SPOT BUBBLES ON POLARIZER NEWTON RING BLACK/WHITE LINE SCRATCH CONTAMINATION LEVER COLOR SPREED 	
MINOR DEFECT	2.BEZEL ZONE	STAINSSCRATCHESFOREIGN MATTER	1.0
	3.SOLDERING	 INSUFFICIENT SOLDER SOLDERED IN INCORRECT POSITION CONVEX SOLDERING SPOT SOLDER BALLS SOLDER SCRAPS 	
	4.DISPLAY ON (ALL ON)	• LIGHT LINE	

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13.3.2 MODULE DEFECTS CALSSIFICATION

NO.	ITEM	CRITERIA			
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC			
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND SPEC			
3.	DOT DEFECT	(1) INSPECTION PATTERN: FULL WHITE, FULL BLACK, RED, GREEN AND BLUE SCREENS. (2) ITEMS ACCEPTABLE COUNT BRIGHT DOT N≤2 DARK DOT TOAL BRIGHT AND DARK DOTS N≤4 NOTE: 1. THE DEFINITION OF DOT: THE SIZE OF A DEFECTIVE DOT OVER 1/2 OF WHOLE DOT IS REGARDED AS ONE DEFECTIVE DOT. 2. BRIGHT DOT: DOTS APPEAR BRIGHT AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER BLACK PATTERN. 3. DARK DOT: DOTS APPEAR DARK AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER PURE RED, GREEN, BLUE PICTURE.			
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA	LENGTH: L $L \le 0.3$ $0.3 < L \le 2.5$ $2.5 < L$	WIDTH: W $W \le 0.05$ $0.05 < W \le 0.1$ $0.1 < W$	PERMISSIBLE NO. IGNORE 4 NONE	EOL TICTORE.
5.	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	WIDTH: W mm, LENGH: L mm AVERAGE DIAMETER (mm): D $D \le 0.15$ $0.15 < D \le 0.5$ $0.5 < D$ NOTE: DIAMETER D=(a+b)/2		NUMBER OF PIECES IGNORI 4 NONE	

NO.	ITEM	CRITERIA			
			AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED	
		DUDDI E ON THE	D ≤ 0.25	IGNORE	
		BUBBLE ON THE POLARIZER	$0.25 < D \le 0.5$	N ≤ 5	
		I OLARIZER	0.5 < D	NOTE	
		SURFACE STATUS	D < 0.1 mm	IGNORE	
			$0.1 < D \le 0.3$ mm	N ≤ 3	
		CF FAIL / SPOT	D < 0.1 mm	IGNORE	
			$0.1 < D \le 0.3$ mm	N ≤ 3	
6.	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	NOTE: (1)POLARIZER BUBBLE IS DEFINED AS THE BUBBLE APPEARS ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA. (2)THE EXTRANEOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON. (3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING. AVERAGE DIAMETER (D)=(a+b)/2			
7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOW			
8.	MURA ON DISPLAY	IT'S OK IF MURA IS SLIGHT VISIBLE THROUNG 6% ND FILTER			
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.			
10.	BEZEL APPEARANCE	(1)BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION. (2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.			
11	РСВ	(1)THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE THAN THREE PLACES. (2)NO OXIDATION OR CONTAMINATION PCB TERMINALS. (3)PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION CHARACTERISTIC CHART. THERE SHOULD BE NO WRONG PARTS, MISSING PARTS OR EXCESS PARTS. (4)THE JUMPER ON THE PCB SHOULD CONFORM TO THE PRODUCT CHARACTERISTIC CHART. (5)IF SOLDER GETS ON BEZEL TAB PADS, LED PAD, ZEBRA PAD OR SCREW HOLD PAD, MAKE SURE IT IS SMOOTHED DOWN.			

NO. ITEM	CRITERIA
	(1)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICENT SOLDER (a)LSI, IC
	A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD
	SOLDER FILLET
	(b)CHIP COMPONENT • SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING
	SOLDER FILLET
12. SOLDERING	 SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED
	SOLDER
	(3)PARTS ALIGMENT (a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE

NO.	ITEM	CRITERIA
	SOLDERING	(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
12.		
		(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. (6)NO RESIDUE OR SOLDER BALLS ON PCB. (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.
13.	BACKLIGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
(4)BACKLIGHT DOESN'T LIGHT OR CO (1)NO OXIDATION, CONTAMINATION, INTERFACE PIN (OLB) OF TCP. (2)NO CRACKS ON INTERFACE PIN (OL (3)NO CONTAMINATION, SOLDER RES ON PRODUCT. (4)THE IC ON THE TCP MAY NOT BE D. (5)THE UPPERMOST EDGE OF THE PROINTERFACE PIN MUST BE PRESENT INTERFACE PIN TO SEVER. (6)THE RESIDUAL ROSIN OR TIN OIL OF (COMPONENT OR CHIP COMPONENT OR CHIP COM		 (2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP. (3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. (4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. (5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. (6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. (7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. (8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. (9)LCD PIN LOOSE OR MISSING PINS. (10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. (11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO

NO.	ITEM	CRITERIA		
	CRACKED GLASS	GENERAL GLASS CHIP:	a b c ≤t/2 <viewing 2="" 8x="" area="" t="" ≤1="">,≤2t ≤W/2 ≤1/8X *W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS</viewing>	
15. 0		CORNER PART: CHIP ON ELECTRODE PAD a a	$ \begin{array}{ c c c c }\hline a & b & c \\\hline & \leq t/2 & < VIEWING AREA & \leq 1/8X \\\hline > t/2 & , \leq 2t & \leq W/2 & \leq 1/8X \\\hline *W=DISTANCE BETWEEN \\ SEALANT AREA AND LCD \\ PANEL EDGE \\ X = LCD SIDE LENGTH \\ t = GLASS THICKNESS \\\hline \hline & a & b & c \\\hline & \leq t & \leq 0.5 \text{mm} & \leq 1/8X \\\hline * X=LCD SIDE WIDTH \\\hline \end{array} $	
		c a	t =GLASS THICKNESS a b c c st s 1/8x s t s L *X=LCD SIDE WIDTH t = GLASS THICKNESS L=ELECTRODE PAD LENGTH ①IF GLASS CHIPPING THE ITO TERMINAL, OVER 2/3 OF THE ITO MU REMAIN AND BE, INSPECTED ACCORDING TO ELECTRODE TERMINAL SPECIFICATIONS ②IF THE PRODUCT WILL BE HEAT SEALED BY THE CUSTOMER, THE ALIGNMENT MARK MUST NOT BE DEMAGED	

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13.4 RELIABILITY TEST

13.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +60°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -10°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
5	HIGH TEMP / HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: -40°C FOR 30 MINUTES ~ +80°C FOR 30 MINUTES
7	ESD (ELECTROSTATIC DISCHARGE) (NOT OPERATED)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV

NOTE (1): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

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13.5 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 12.5, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

13.6 OPERATION

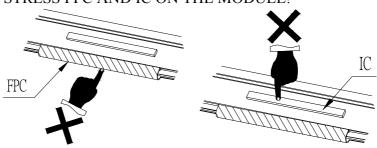
- 13.6.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 13.6.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 13.6.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 13.6.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND

REACHES THE SPECIFIED VALUE.

IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH - UP PROBLEM.

13.6.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

DO NOT STRESS FPC AND IC ON THE MODULE!



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13.7 NOTICE

- 13.7.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING , TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD .
- 13.7.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 13.7.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 13.7.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 13.7.5 DON'T GIVE EXTERNAL SHOCK.
- 13.7.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 13.7.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.
 WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 13.7.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 13.7.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 13.7.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 13.7.11 REWIRING: NO MORE THAN 3 TIMES.